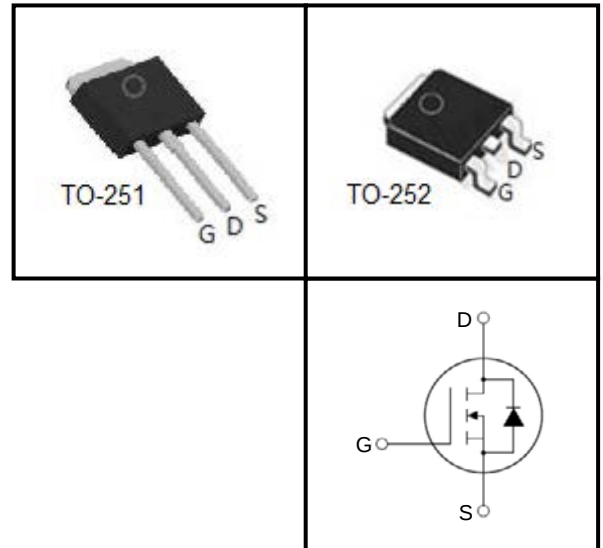


FEATURES

- Very low FOM $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information		
Device	Package	Marking
SP60R1K8U	TO-251	SP60R1K8U
SP60R1K8T	TO-252	SP60R1K8T

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted				
Parameter	Symbol	Value		Unit
		TO-251	TO-252	
Drain-Source Voltage ($V_{GS} = 0\text{V}$)	V_{DSS}	600		V
Continuous Drain Current	I_D	2		A
Pulsed Drain Current (note1)	I_{DM}	6		A
Gate-Source Voltage	V_{GSS}	± 30		V
Single Pulse Avalanche Energy (note2)	E_{AS}	20		mJ
Avalanche Current (note1)	I_{AR}	0.5		A
Repetitive Avalanche Energy (note1)	E_{AR}	0.05		mJ
Power Dissipation ($T_C = 25^\circ\text{C}$)	P_D	24		W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	$-55 \sim +150$		$^\circ\text{C}$

Thermal Resistance				
Parameter	Symbol	Value		Unit
		TO-251	TO-252	
Thermal Resistance, Junction-to-Case	R _{thJC}	5.2		K/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62		

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	600	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA
		V _{DS} = 600V, V _{GS} = 0V, T _J = 150°C	--	--	100	
Gate-Source Leakage	I _{GSS}	V _{GS} = ±30V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.5	--	4.0	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 1A	--	1.8	2.0	Ω
Forward Transconductance (Note3)	g _{fs}	V _{DS} = 10V, I _D = 1A	--	2	--	S
Dynamic						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 50V, f = 1.0MHz	--	182	--	pF
Output Capacitance	C _{oss}		--	11	--	
Reverse Transfer Capacitance	C _{rss}		--	1.5	--	
Total Gate Charge	Q _g	V _{DD} = 480V, I _D = 2A, V _{GS} = 10V	--	5.1	--	nC
Gate-Source Charge	Q _{gs}		--	0.9	--	
Gate-Drain Charge	Q _{gd}		--	2.1	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 400V, I _D = 2A, R _G = 25Ω	--	30	--	ns
Turn-on Rise Time	t _r		--	29	--	
Turn-off Delay Time	t _{d(off)}		--	54	--	
Turn-off Fall Time	t _f		--	31	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I _S	T _C = 25°C	--	--	2	A
Pulsed Diode Forward Current	I _{SM}		--	--	6.3	
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 2A, V _{GS} = 0V	--	0.9	1.2	V
Reverse Recovery Time	t _{rr}	V _R = 480V, I _F = I _S , di _F /dt = 100A/μs	--	150	--	ns
Reverse Recovery Charge	Q _{rr}		--	0.5	--	μC
Peak Reverse Recovery Current	I _{rrm}		--	6.0	--	A

Notes

1. Repetitive Rating: Pulse Width limited by maximum junction temperature
2. $I_{AS} = 0.5A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 1\%$

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

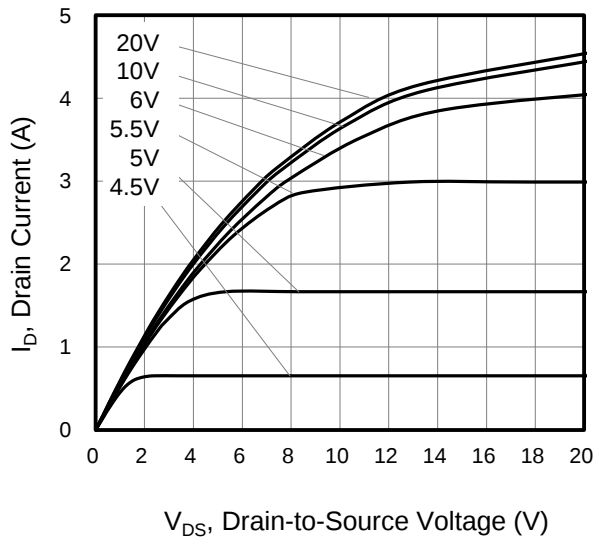


Figure 2. Transfer Characteristics

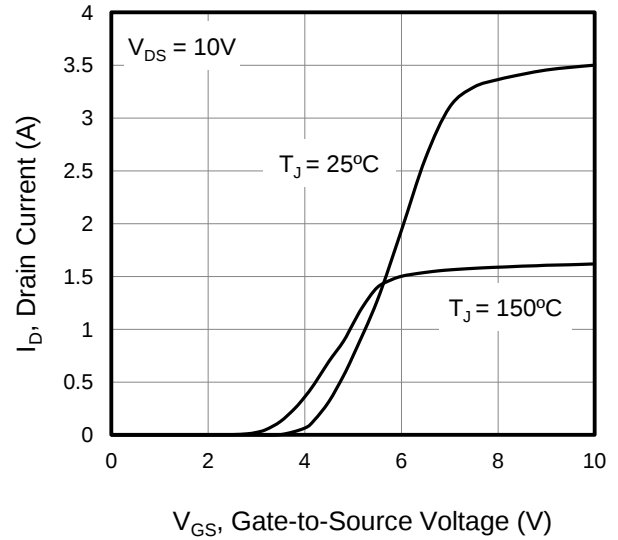


Figure 3. On-Resistance vs. Drain Current

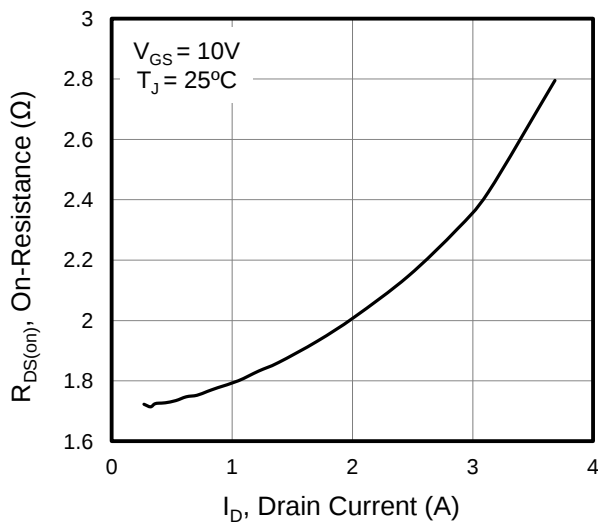


Figure 4. Capacitance

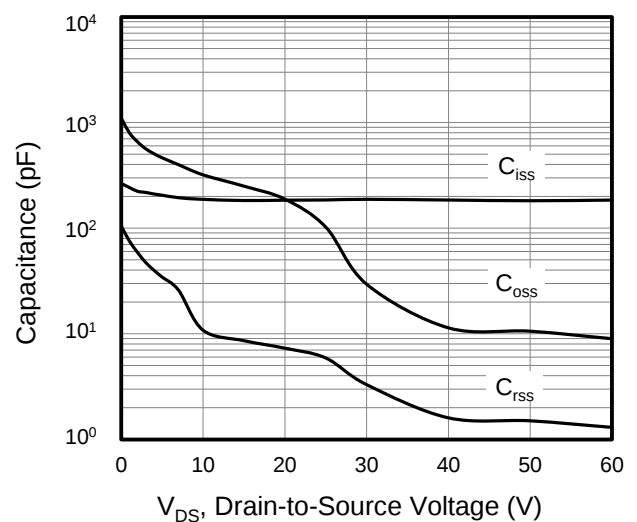


Figure 5. Gate Charge

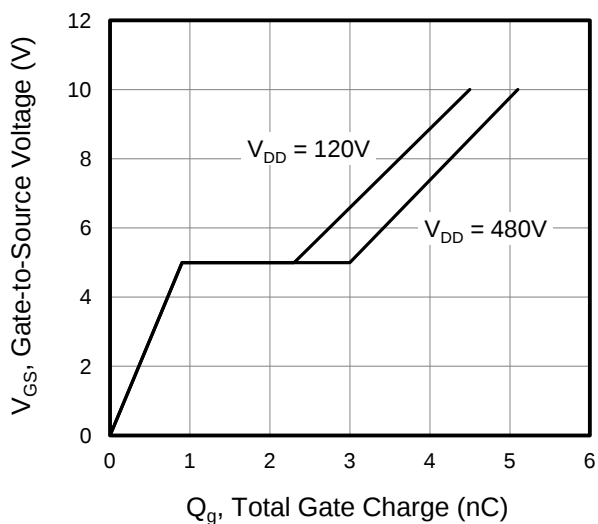
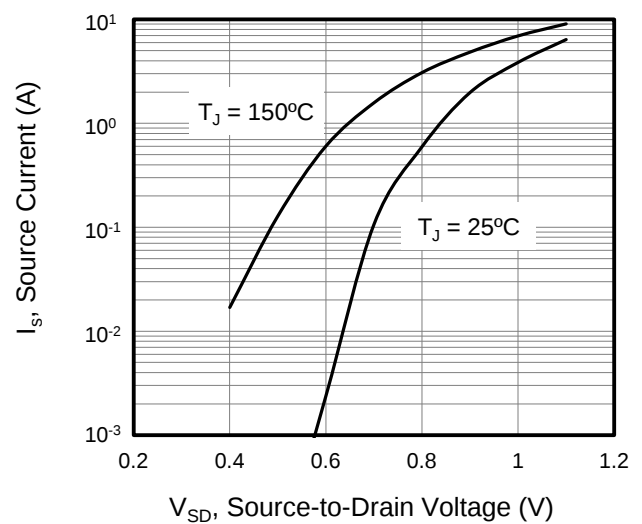


Figure 6. Body Diode Forward Voltage



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. On-Resistance vs. Junction Temperature

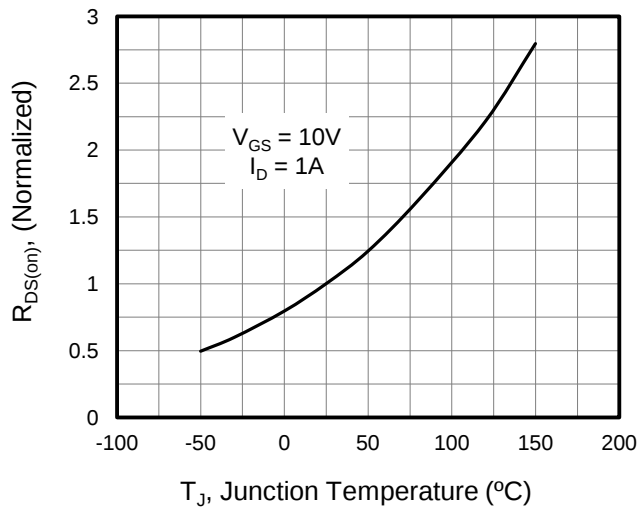


Figure 8. Threshold Voltage vs. Junction Temperature

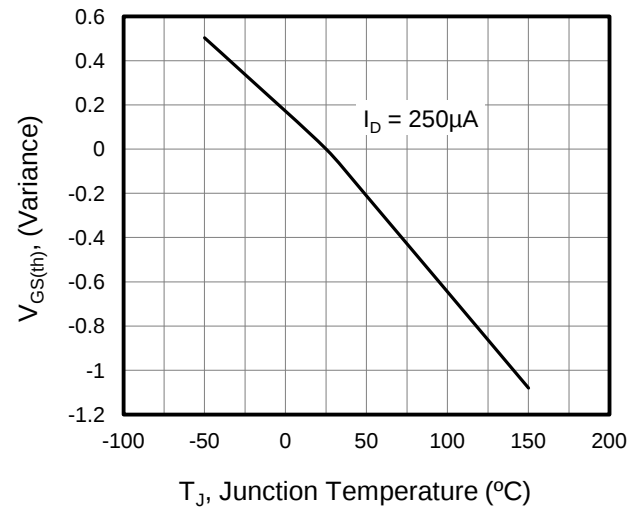


Figure 9. Transient Thermal Impedance TO-251/TO-252

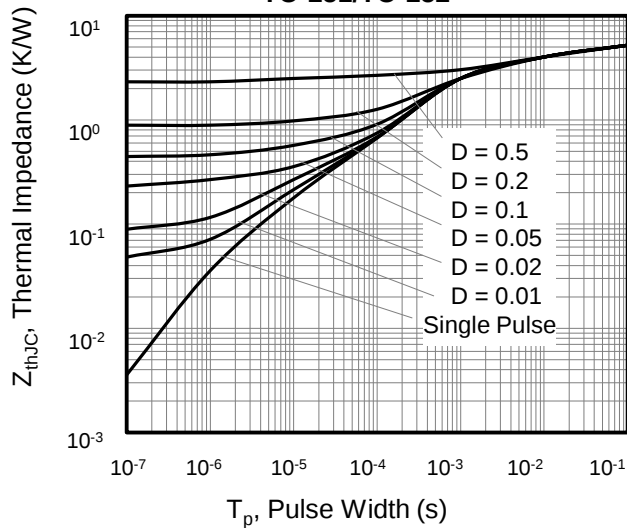


Figure A: Gate Charge Test Circuit and Waveform

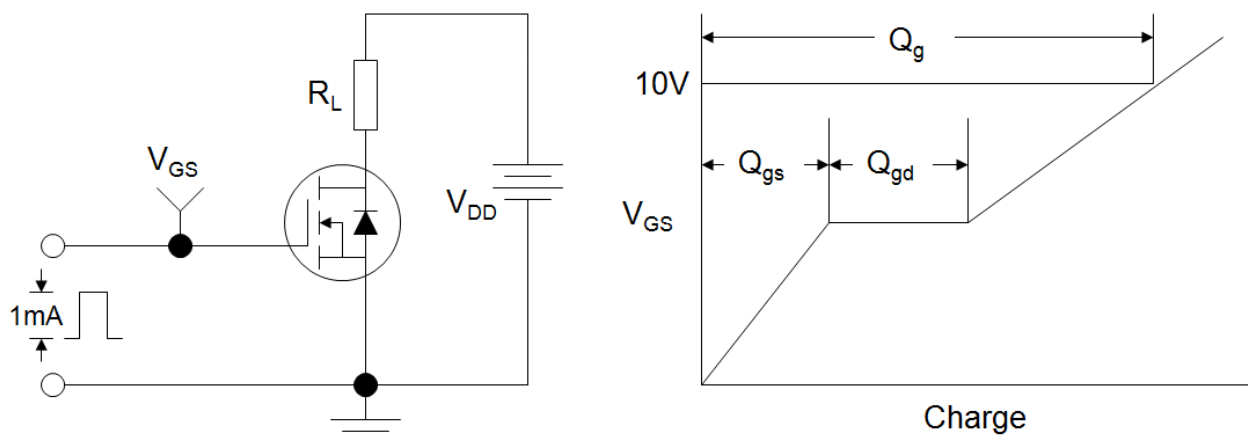


Figure B: Resistive Switching Test Circuit and Waveform

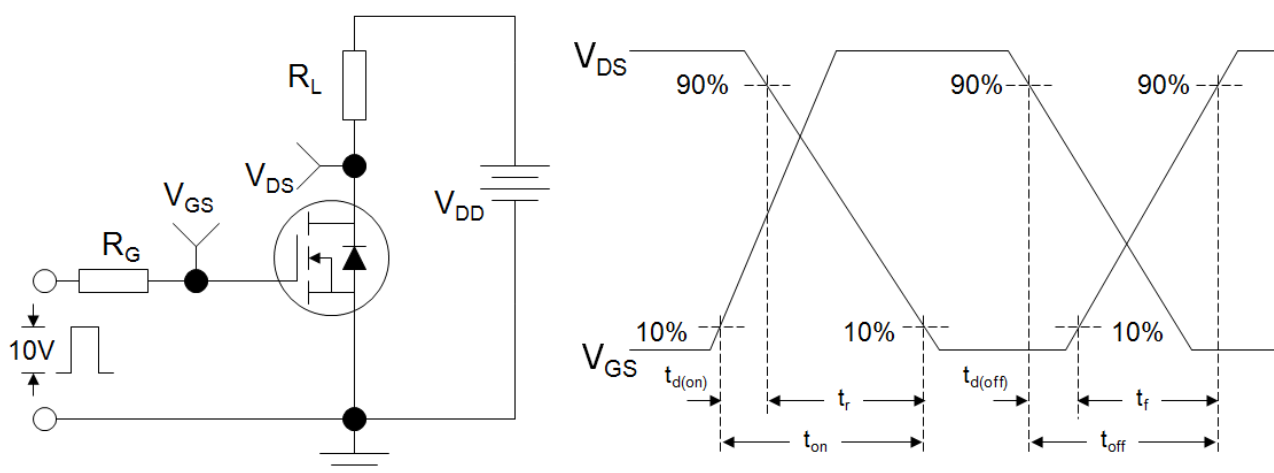
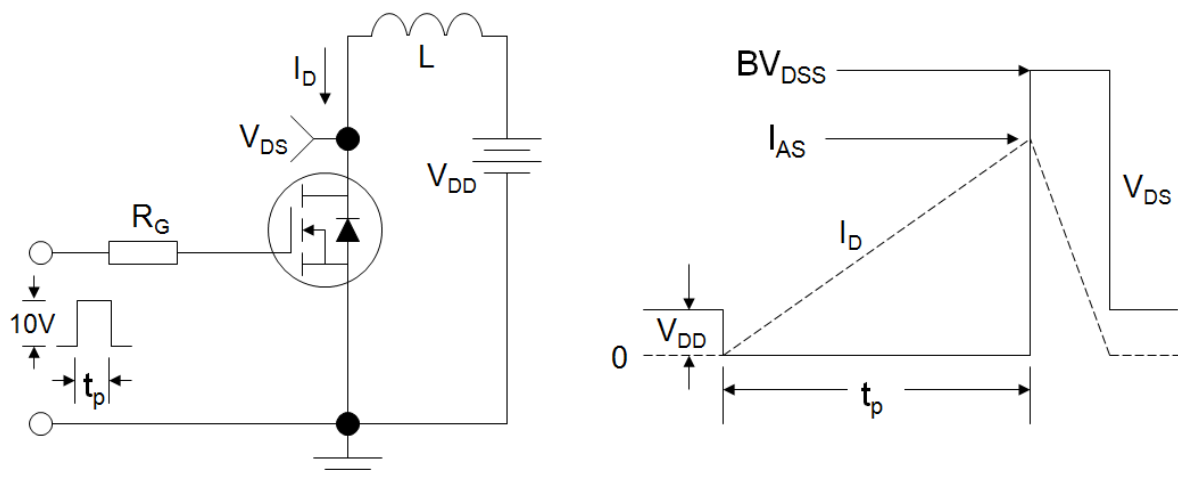
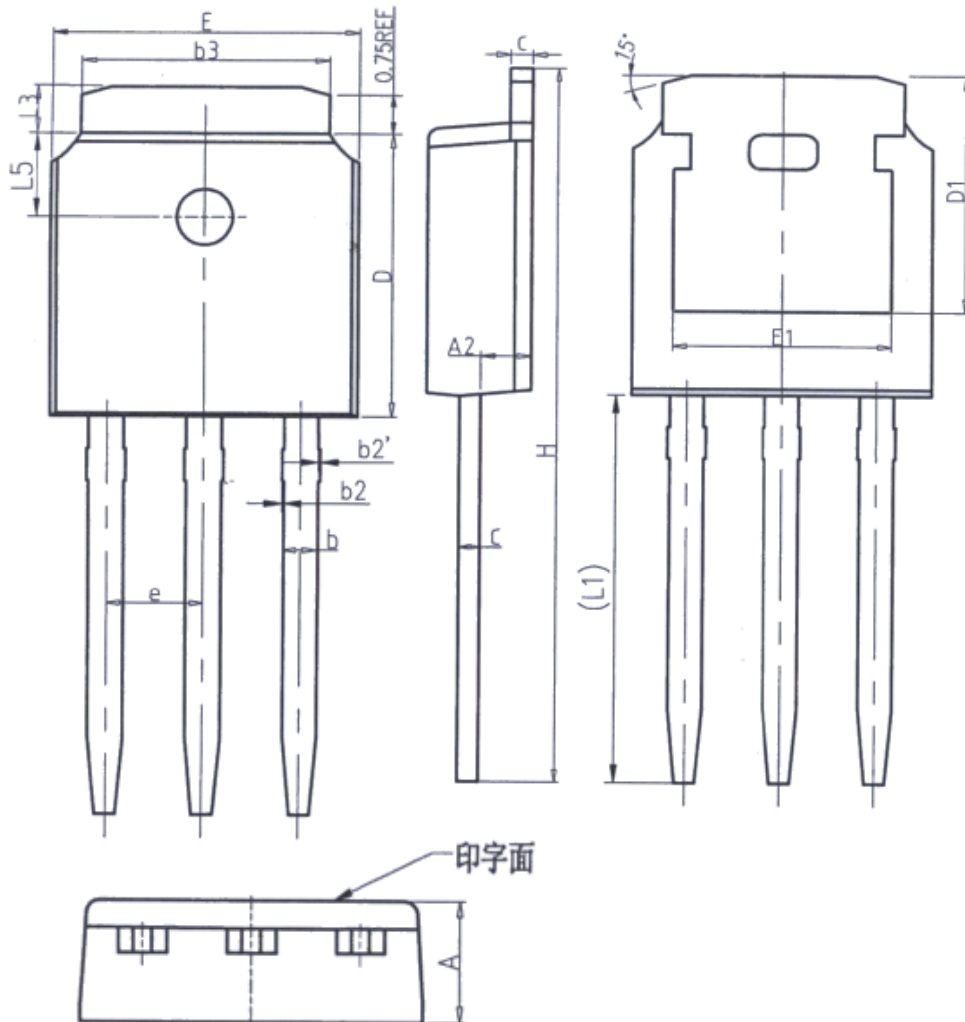


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



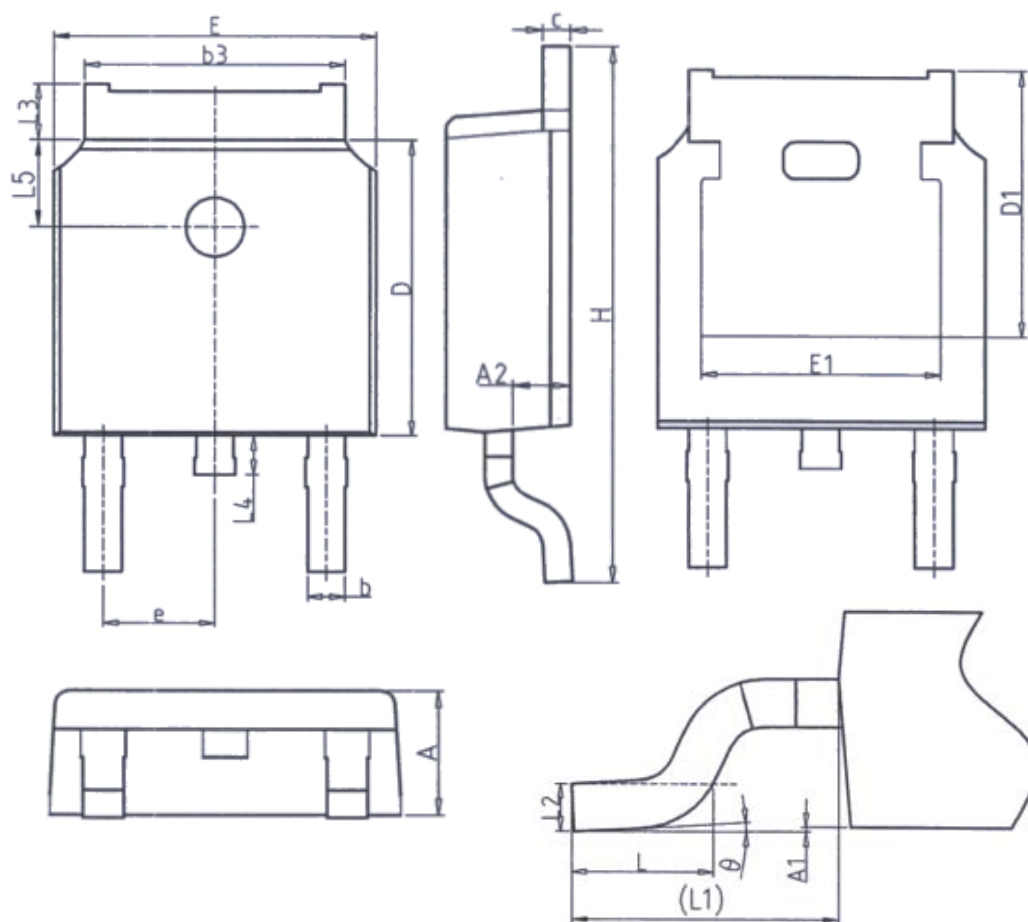
TO-251



Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A2	0.97	1.17
b	0.68	0.90
b2	0.00	0.10
b2'	0.00	0.10
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22

Unit: mm		
Symbol	Min.	Max.
D1	5.30REF	
E	6.40	6.80
E1	4.63	-
e	2.286BSC	
H	16.22	16.82
L1	9.15	9.65
L3	0.88	1.28
L5	1.65	1.95

TO-252



Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A1	0.00	0.20
A2	0.97	1.17
b	0.68	0.90
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22
D1	5.30REF	
E	6.40	6.80
E1	4.63	-

Unit: mm		
Symbol	Min.	Max.
e	2.286BSC	
H	9.40	10.50
L	1.38	1.75
L1	2.90REF	
L2	0.51BSC	
L3	0.88	1.28
L4	-	1.00
L5	1.65	1.95
θ	0°	8°